



Material Content Data Sheet



Sales Product Name	SAK-TC234L-32F200F AC			Issued		16. October 2019		
MA#	MA003773046							
Package	PG-TQFP-144-27			Weight*		699.45 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	23.351	3.34	3.34	33385	33385
leadframe	inorganic material	phosphorus	7723-14-0	0.066	0.01		95	
	non noble metal	zinc	7440-66-6	0.265	0.04		379	
	non noble metal	iron	7439-89-6	5.302	0.76		7580	
	non noble metal	copper	7440-50-8	215.278	30.78	31.59	307782	315836
wires	noble metal	gold	7440-57-5	0.002	0.00		3	
	noble metal	palladium	7440-05-3	0.042	0.01		59	
	non noble metal	copper	7440-50-8	1.844	0.26	0.27	2636	2698
encapsulation	organic material	carbon black	1333-86-4	1.328	0.19		1899	
	plastics	epoxy resin	-	56.224	8.04		80383	
	inorganic material	silicondioxide	60676-86-0	385.155	55.07	63.30	550651	632933
leadfinish	noble metal	palladium	7440-05-3	0.003	0.00		4	
	noble metal	silver	7440-22-4	0.003	0.00		4	
	noble metal	gold	7440-57-5	0.005	0.00		7	
	non noble metal	nickel	7440-02-0	4.713	0.67	0.67	6739	6754
plating	noble metal	palladium	7440-05-3	0.000	0.00		1	
	noble metal	silver	7440-22-4	0.000	0.00		1	
	noble metal	gold	7440-57-5	0.000	0.00		1	
	non noble metal	nickel	7440-02-0	0.366	0.05	0.05	523	526
glue	plastics	epoxy resin	-	1.211	0.17		1731	
	noble metal	silver	7440-22-4	4.292	0.61	0.78	6137	7868
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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